



#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Features**

- Low On-Resistance
  - $25m\Omega$  @  $V_{GS} = 4.5V$
  - $29m\Omega @ V_{GS} = 2.5V$
  - $36m\Omega$  @  $V_{GS} = 1.8V$
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Up To 2kV
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

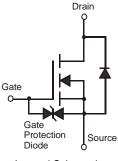
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (approximate)

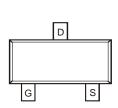




Top View







Top View

Internal Schematic

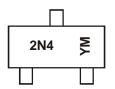
Ordering Information (Note 3)

Part Number		Qualification	Case	Packaging
	DMG6968U-7	Commercial	SOT23	3000/Tape & Reel
	DMG6968UQ-7	Automotive	SOT23	3000/Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



2N4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009)M = Month (ex: 9 = September)

Date Code Key

Year	200	9	2010		2011	20	12	2013		2014	2	2015
Code	W		X		Υ	2	7	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characte	eristic		Symbol	Value	Units
Drain-Source Voltage			$V_{DSS}$	20	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 4)	Steady State	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	6.5 5.2	А
Pulsed Drain Current		I <sub>DM</sub>	30	Α	

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_{D}$	1.3	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = 25°C	$R_{ heta JA}$	157	°C/W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-55 to +150	°C

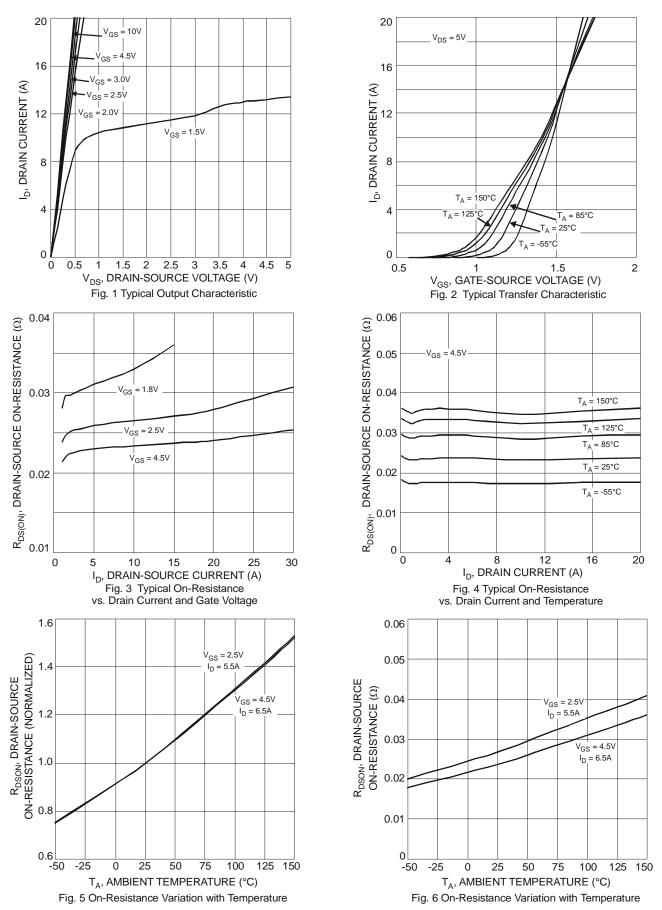
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 5)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_		V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T <sub>J</sub> =	25°C I <sub>DSS</sub>	_	_	1.0	μΑ	$V_{DS} = 20V$ , $V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 10V, V_{DS} = 0V$		
Gate-Source Breakdown Voltage	BV <sub>SGS</sub>	±12	-	1	V	$V_{DS} = 0V, I_{G} = \pm 250 \mu A$		
ON CHARACTERISTICS (Note 5)								
Gate Threshold Voltage	$V_{GS(th)}$	0.5	_	0.9	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
			21	25		$V_{GS} = 4.5V, I_D = 6.5A$		
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	_	23	29	$m\Omega$	$V_{GS} = 2.5V, I_D = 5.5A$		
			28	36		$V_{GS} = 1.8V, I_D = 3.5A$		
Forward Transfer Admittance	Y <sub>fs</sub>	_	8	_	S	$V_{DS} = 10V, I_{D} = 5A$		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C <sub>iss</sub>	_	151		pF	1/ 401/1/ 01/		
Output Capacitance		_	91		pF	$V_{DS} = 10V, V_{GS} = 0V$ - f = 1.0MHz		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	32		pF	1 = 1.000112		
Total Gate Charge	$Q_g$	_	8.5		nC			
Gate-Source Charge	$Q_{gs}$	_	1.6	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 6.5A$		
Gate-Drain Charge	Q <sub>gd</sub>	_	2.8	_	nC			
Turn-On Delay Time	t <sub>D(on)</sub>	_	54	_	ns			
Turn-On Rise Time	tr	_	66	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$		
Turn-Off Delay Time	t <sub>D(off)</sub>	_	613	_	ns	$R_L = 10\Omega$ , $R_G = 6\Omega$ , $I_D = 1A$		
Turn-Off Fall Time	t <sub>f</sub>	_	205	_	ns			

Notes:

- 4. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal vias to bottom layer 1 inch square copper plate.5. Short duration pulse test used to minimize self-heating effect.







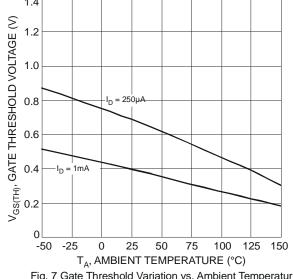
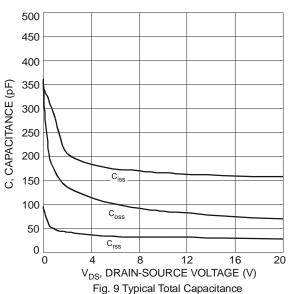
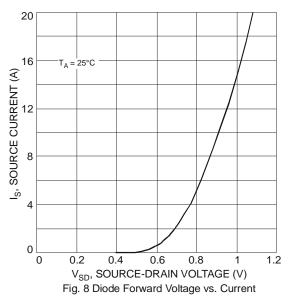


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





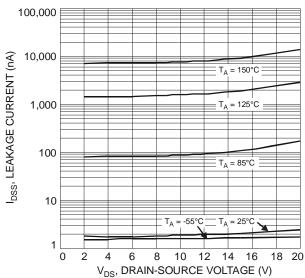


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

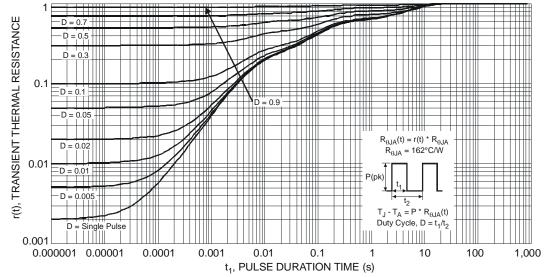
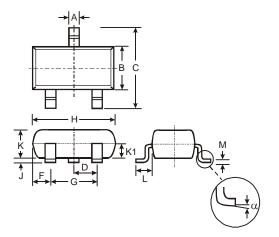


Fig. 11 Transient Thermal Response

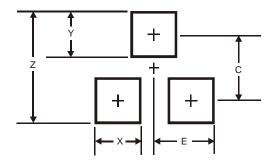


# **Package Outline Dimensions**



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	<b>K</b> 0.903		1.00					
<b>K</b> 1	-	-	0.400					
L	0.45	0.61	0.55					
M	<b>M</b> 0.085		0.11					
α	0°	8°	-					
All	All Dimensions in mm							

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
F	1 35



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